**Components marked 'DNP' should not be populated.**

**Assembly Variant: 001**

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<th>PCB Viewed from Top Side</th>
<th>Board #: PMP40228</th>
<th>Rev: A</th>
<th>SVN Rev: Not In VersionControl</th>
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**Plot Name** = Top Assembly Drawing

**Generated** : 4/7/2017 2:16:11 PM

**Texas Instruments**
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<td>TEXAS INSTRUMENTS</td>
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